



REV.	ECN NO.	REVISED	DATE

1.MATERIAL:

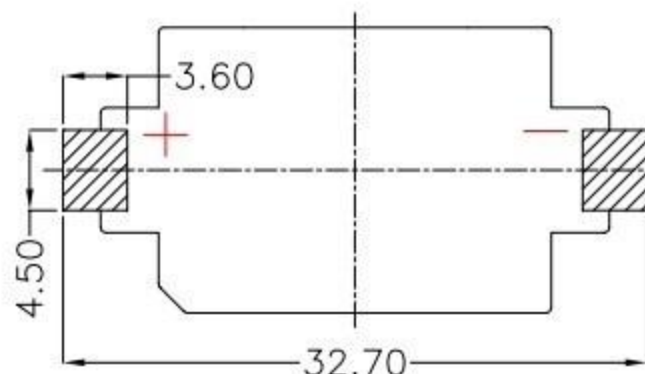
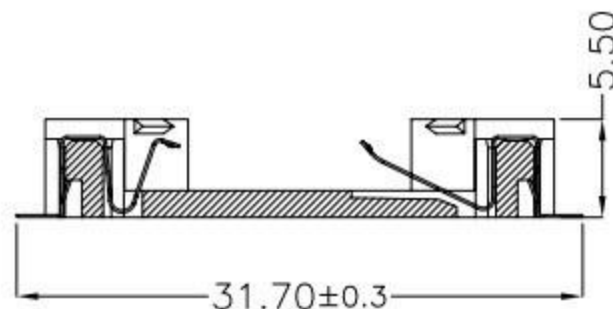
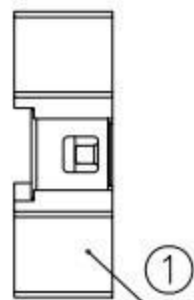
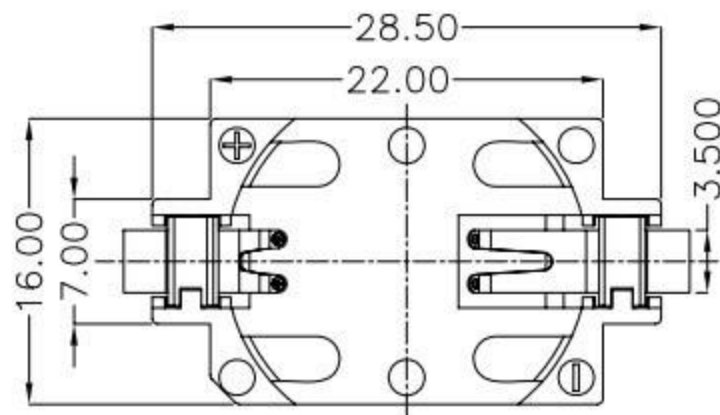
- a.HOUSING:LCP UL94V-0
b.CONTACT:PHOSPHOR BRONZE
(SURFACE PLATING:Au1u")

SEE ORDERING INFORMATION

2.ELECTRIC:

- a.CONTACT RESISTANCE: 30 MILLIOHMS MAX
b.INSULATION RESISTANCE: 1000 MEGA OHMS MIN
c.DIELECTRIC VOLTAGE: 500V AC ONE SEC LEVEL
d.OPERATING TEMPERATURE: -25°C~ +85°C

ORDERING INFORMATION



PCB Layout Diagram
Top View

电池座系列

SMT 180° TYPE

PLATING:
A-Au1U"
J-Ni100U"~120U"
K-Sn100U"~120U"

MATERIAL:
1A-PBT BLACK
1B-PA66 BLACK
2A-PPA BROWN
2B-PPA BLACK
3A-PPS BROWN
3B-PPS BLACK
4A-LCP WHITE
4B-LCP BLACK
5A-PA6T WHITE
5B-PA6T BLACK

UNLESS OTHERWISE
SPECIFIED TOLERANCES



东莞市溪榜电子有限公司
DONG GUAN XI BANG ELECTRONICS CO., LTD.

DECIMALS: ANGLES:
X :±0.30 X :±1°
X.X :±0.25 X.X :±0.5°
X.XX :±0.20
X.XXX :±0.10

DSND
CHKD
APVD
DATE 2017-07-11
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TITLE:
PART NO.:

WEIGHT: 1.49g

SCALE: 2:1 SIZE: A4 VIEW: ④ ⑤

DRAW NO.:

SHEET 1 OF 1

UNIT: mm REV.: A/0 OBJECT: MY

DRAW NO.:

NO.	PART NAME	Q'TY	MATERIAL	PLATING & COLOR
3	TERMINAL(-)	1	PHOSPHOR BRONZE, T=0.15mm	Gold Plating and Ni Under-Plating
2	TERMINAL(+)	1	PHOSPHOR BRONZE, T=0.15mm	Gold Plating and Ni Under-Plating
1	HOUSING	1	LCP	WHITE